

GENERAL DESCRIPTION

The SGM8433-2 is a dual-power, high performance operational amplifier with integrated protection, which is specifically designed for applications involving resolvers. The device features high gain-bandwidth product and high slew rate. It also offers a continuous high output current drive. These characteristics make the device highly suitable for providing the requisite low-distortion, high-level differential excitation essential for activating the primary coil of a resolver. The device integrates over-temperature and current-limit protection to improve the robustness of overall system, particularly in scenarios where analog signals are transmitted through wires that may be vulnerable to errors.

The SGM8433-2 fits in a small package and features low thermal resistance, which permit the transfer of high currents to loads while saving space on the circuit board. The SGM8433-2's enhanced gain-bandwidth feature enables its use as a filter component, while driving high output current. This advantage allows for a more compact design in the resolver drive signal chain by minimizing the overall footprint required. The compact design of the SGM8433-2 stands out as a significant benefit for its integration into industrial systems.

The SGM8433-2 is available in a Green TSSOP-14B (Exposed Pad) package. It is specified over the extended industrial temperature range (-40°C to +125°C).

FEATURES

- **Wide Supply Voltage Range: 4.5V to 24V**
- **Gain-Bandwidth Product: 12MHz**
- **Slew Rate: 35V/μs**
- **Functional-Safety Feature**
- **Over-Temperature Protection**
- **Current-Limit Protection**
- **Shutdown Mode for Applications with Low I_Q**
- **-40°C to +125°C Operating Temperature Range**
- **Available in a Green TSSOP-14B (Exposed Pad) Package**

APPLICATIONS

Exciting Signal Driver of Resolver Primary Coil
Motor Control System
Servo Control System

SIMPLIFIED SCHEMATIC

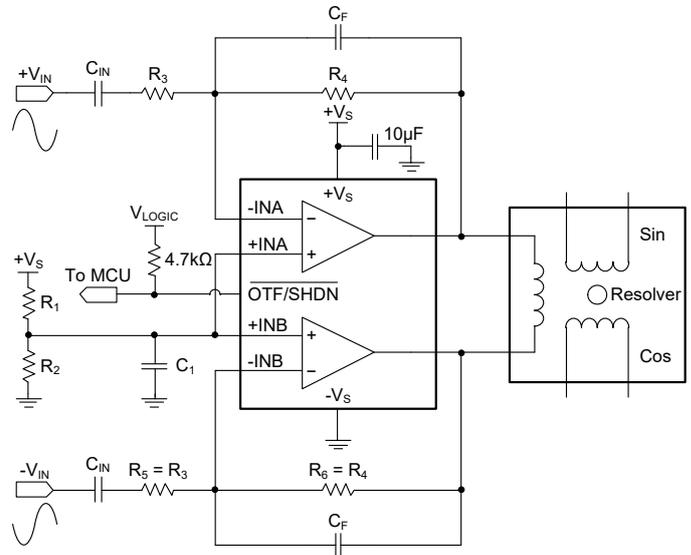


Figure 1. Simplified Schematic for Differential Input

Low-Distortion, Dual-Power Amplifier with Integrated Protection for Resolver Drive

SGM8433-2

PACKAGE/ORDERING INFORMATION

| MODEL | PACKAGE DESCRIPTION | SPECIFIED TEMPERATURE RANGE | ORDERING NUMBER | PACKAGE MARKING | PACKING OPTION |
|-----------|----------------------------|-----------------------------|---------------------|-----------------------------|---------------------|
| SGM8433-2 | TSSOP-14B (Exposed Pad) | -40°C to +125°C | SGM8433-2XPTS14G/TR | SGM84332 XPTS14 XXXXX | Tape and Reel, 4000 |

MARKING INFORMATION

NOTE: XXXXX = Date Code, Trace Code and Vendor Code.

XXXXX



Green (RoHS & HSF): SG Micro Corp defines "Green" to mean Pb-Free (RoHS compatible) and free of halogen substances. If you have additional comments or questions, please contact your SGMICRO representative directly.

ABSOLUTE MAXIMUM RATINGS

| | |
|---|------------------------------------|
| Supply Voltage, V_s | |
| Single Supply | 26V |
| Dual Supply | $\pm 13V$ |
| Signal Input Voltage Terminals | |
| Common Mode | $(-V_s) - 0.5V$ to $(+V_s) + 0.7V$ |
| Differential | $(+V_s) - (-V_s) + 0.2V$ |
| $OTF/SHDN$ Pin Voltage Range, $V_{OTF/SHDN}$ | |
| Common Mode | 0V to 5.5V |
| Output Short-Circuit Current ⁽¹⁾ | Continuous |
| Package Thermal Resistance | |
| TSSOP-14B (Exposed Pad), θ_{JA} | 41.9°C/W |
| TSSOP-14B (Exposed Pad), θ_{JB} | 20.9°C/W |
| TSSOP-14B (Exposed Pad), $\theta_{JC(TOP)}$ | 41.3°C/W |
| TSSOP-14B (Exposed Pad), $\theta_{JC(BOT)}$ | 4.3°C/W |
| Junction Temperature | +150°C |
| Storage Temperature Range | -65°C to +150°C |
| Lead Temperature (Soldering, 10s) | +260°C |
| ESD Susceptibility ^{(2) (3)} | |
| HBM | $\pm 8000V$ |
| CDM | $\pm 1000V$ |

NOTES:

- Each package contains one amplifier, which can be shorted to ground.
- For human body model (HBM), all pins comply with ANSI/ESDA/JEDEC JS-001 specifications.
- For charged device model (CDM), all pins comply with ANSI/ESDA/JEDEC JS-002 specifications.

RECOMMENDED OPERATING CONDITIONS

| | |
|-----------------------------------|--------------------------|
| Supply Voltage Range, V_s | |
| Single Supply | 4.5V to 24V |
| Dual Supply | $\pm 2.25V$ to $\pm 12V$ |
| Operating Temperature Range | -40°C to +125°C |

OVERSTRESS CAUTION

Stresses beyond those listed in Absolute Maximum Ratings may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect reliability. Functional operation of the device at any conditions beyond those indicated in the Recommended Operating Conditions section is not implied.

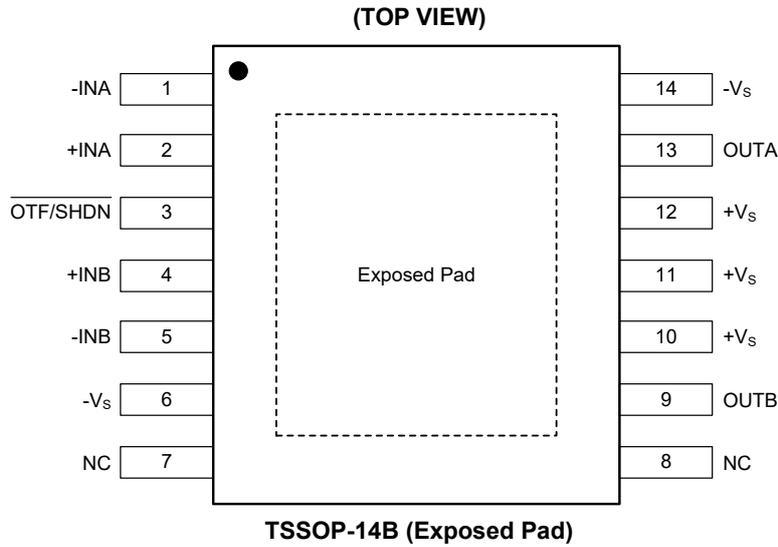
ESD SENSITIVITY CAUTION

This integrated circuit can be damaged if ESD protections are not considered carefully. SGMICRO recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage. ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because even small parametric changes could cause the device not to meet the published specifications.

DISCLAIMER

SG Micro Corp reserves the right to make any change in circuit design, or specifications without prior notice.

PIN CONFIGURATION



PIN DESCRIPTION

| PIN | NAME | I/O | FUNCTION |
|-------------|------------------------------|-----|---|
| 1 | -INA | I | Inverting Input of Amplifier A. |
| 2 | +INA | I | Non-Inverting Input of Amplifier A. |
| 3 | $\overline{\text{OTF/SHDN}}$ | I/O | Over-Temperature Flag and Shutdown. When the $\overline{\text{OTF/SHDN}}$ pin is high ($> V_{IH_OTF}$), the operational amplifier is operating. When the $\overline{\text{OTF/SHDN}}$ pin is low ($< V_{IL_OTF}$), the operational amplifier is in shutdown mode (low I_Q state). |
| 4 | +INB | I | Non-Inverting Input of Amplifier B. |
| 5 | -INB | I | Inverting Input of Amplifier B. |
| 6, 14 | -Vs | — | Negative Supply. The dual negative supply points must be used and interconnected on the circuit board. |
| 7, 8 | NC | — | Not Connected. |
| 9 | OUTB | O | Output of Amplifier B. |
| 10, 11, 12 | +Vs | — | Positive Supply. |
| 13 | OUTA | O | Output of Amplifier A. |
| Exposed Pad | Exposed Pad | — | The exposed pad can be connected to -Vs or left floating. Connect it to -Vs plane to maximize thermal performance. Ensure that the exposed pad is exclusively connected to the -Vs pin and not to any other pins. |

ELECTRICAL CHARACTERISTICS

($V_S = 4.5V$ to $24V$, $V_{CM} = V_{OUT} = V_S/2$, and $R_L = 10k\Omega$ connected to $V_S/2$, Full = $-40^\circ C$ to $+125^\circ C$, typical values are at $T_A = +25^\circ C$, unless otherwise noted.)

| PARAMETER | | SYMBOL | CONDITIONS | TEMP | MIN | TYP | MAX | UNITS |
|---------------------------------|--------------|--------------------------|--|-------|----------------|-----------|--------------------|----------|
| Input Characteristics | | | | | | | | |
| Input Offset Voltage | | V_{OS} | | +25°C | | ±1 | ±6 | mV |
| | | | | Full | | | ±7 | |
| Input Offset Voltage Drift | | $\Delta V_{OS}/\Delta T$ | | Full | | ±5 | ±20 ⁽¹⁾ | μV/°C |
| Input Bias Current | | I_B | | +25°C | | ±20 | ±300 | pA |
| | | | | Full | | | ±15 | nA |
| Input Offset Current | | I_{OS} | | +25°C | | ±20 | ±300 | pA |
| | | | | Full | | | ±5 | nA |
| Input Common Mode Voltage Range | | V_{CM} | | +25°C | $(-V_S) - 0.2$ | | $(+V_S) + 0.2$ | V |
| Common Mode Rejection Ratio | | CMRR | $V_S = 4.5V, V_{CM} = (-V_S) - 0.2V$ to $(+V_S) + 0.2V$ | +25°C | 71 | 90 | | dB |
| | | | | Full | 68 | | | |
| | | | $V_S = 4.5V, V_{CM} = (-V_S) + 2.5V$ to $(+V_S) + 0.2V$ | +25°C | 89 | 112 | | |
| | | | | Full | 86 | | | |
| | | | $V_S = 24V, V_{CM} = (-V_S) - 0.2V$ to $(+V_S) + 0.2V$ | +25°C | 84 | 102 | | |
| | | | | Full | 81 | | | |
| | | | $V_S = 24V, V_{CM} = (-V_S) + 2.5V$ to $(+V_S) + 0.2V$ | +25°C | 109 | 126 | | |
| | | | | Full | 104 | | | |
| Input Impedance | Differential | Z_{ID} | | +25°C | | 20 0.8 | | MΩ pF |
| | Common Mode | Z_{IC} | | +25°C | | 0.5 8 | | GΩ pF |
| Open-Loop Voltage Gain | | A_{OL} | $V_S = 4.5V, (-V_S) + 0.5V < V_{OUT} < (+V_S) - 0.5V$ | +25°C | 94 | 120 | | dB |
| | | | | Full | 90 | | | |
| | | | $V_S = 4.5V, (-V_S) + 1.5V < V_{OUT} < (+V_S) - 1.5V, R_L = 225\Omega$ | +25°C | 86 | 110 | | |
| | | | | Full | 83 | | | |
| | | | $V_S = 24V, (-V_S) + 0.5V < V_{OUT} < (+V_S) - 0.5V$ | +25°C | 109 | 134 | | |
| | | | | Full | 106 | | | |
| | | | $V_S = 24V, (-V_S) + 1.5V < V_{OUT} < (+V_S) - 1.5V, R_L = 225\Omega$ | +25°C | 107 | 128 | | |
| | | | | Full | 103 | | | |
| Output Characteristics | | | | | | | | |
| Output Voltage Swing from Rail | | | $I_{OUT} = \pm 5mA$ | +25°C | | 20 | 30 | mV |
| | | | | Full | | | 35 | |
| Output Short-Circuit Current | | I_{SC} | Sinking | +25°C | 280 | 400 | 510 | mA |
| | | | Sourcing | +25°C | 230 | 360 | 500 | |
| Power Supply | | | | | | | | |
| Operating Voltage Range | | V_S | | Full | 4.5 | | 24 | V |
| Power Supply Rejection Ratio | | PSRR | $V_S = \pm 2.25V$ to $\pm 12V$ | +25°C | 104 | 126 | | dB |
| | | | | Full | 100 | | | |
| Total Quiescent Current | | I_Q | $I_{OUT} = 0A$ | Full | | 5 | 7.5 | mA |

NOTE: 1. This is guaranteed by design and tested by limited samples, and is not covered by manufacture testing.

SGM8433-2 Low-Distortion, Dual-Power Amplifier with Integrated Protection for Resolver Drive

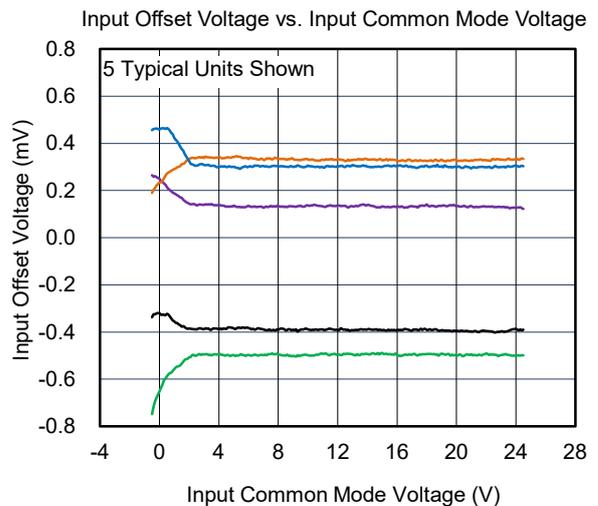
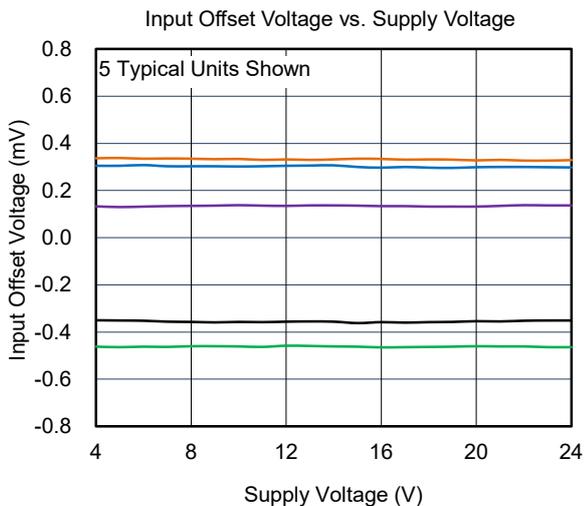
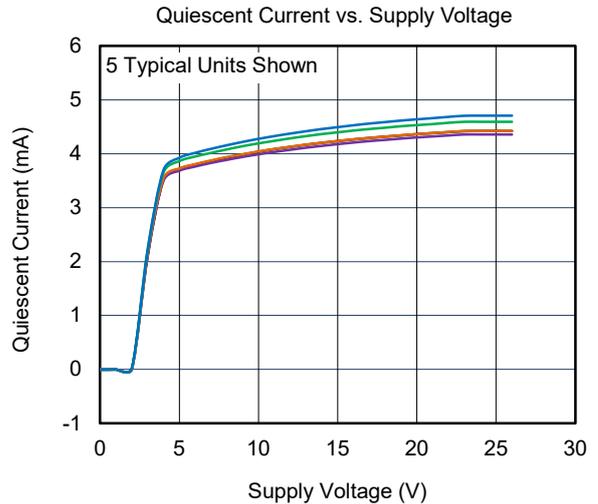
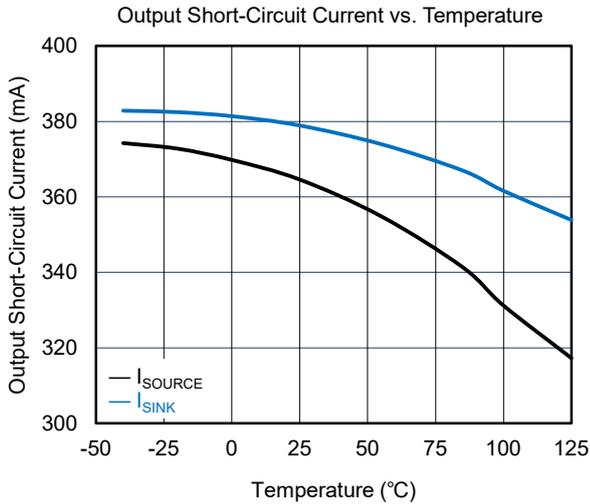
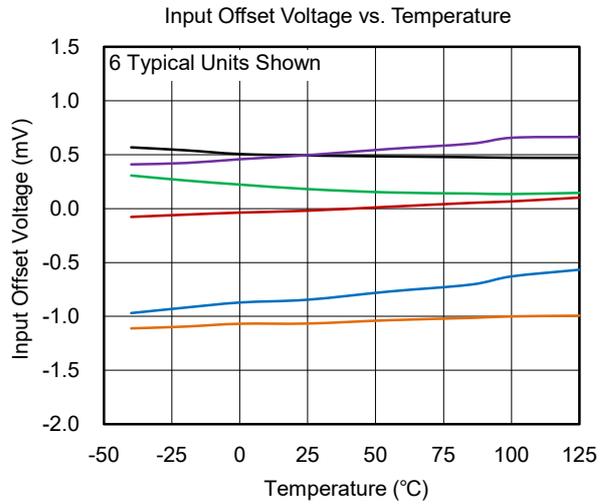
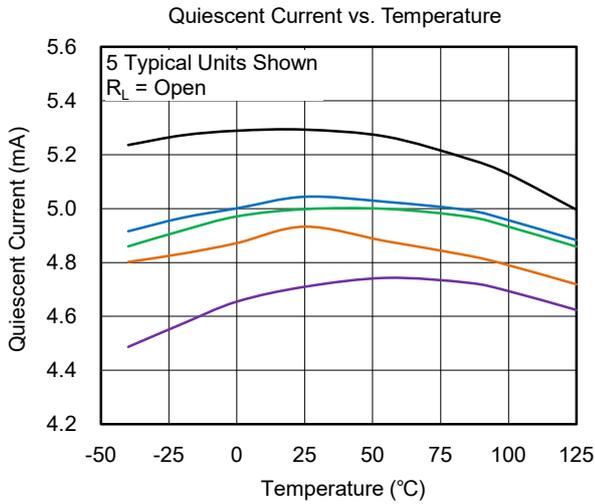
ELECTRICAL CHARACTERISTICS (continued)

($V_S = 4.5V$ to $24V$, $V_{CM} = V_{OUT} = V_S/2$, and $R_L = 10k\Omega$ connected to $V_S/2$, Full = $-40^\circ C$ to $+125^\circ C$, typical values are at $T_A = +25^\circ C$, unless otherwise noted.)

| PARAMETER | SYMBOL | CONDITIONS | TEMP | MIN | TYP | MAX | UNITS |
|-----------------------------------|----------------|---|-------|-----|-----|-----|----------------|
| Dynamic Performance | | | | | | | |
| Gain-Bandwidth Product | GBP | | +25°C | | 12 | | MHz |
| Slew Rate | SR | $V_S = 4.5V$, 4V step, $G = +1$ | +25°C | | 20 | | V/ μs |
| | | $V_S = 24V$, 10V step, $G = +1$ | +25°C | | 35 | | |
| Settling Time to 0.1% | t_s | $V_S = 24V$, 10V step, $G = +1$, $C_L = 10pF$ | +25°C | | 0.6 | | μs |
| | | $V_S = 24V$, 10V step, $G = -1$, $C_L = 10pF$ | +25°C | | 0.6 | | |
| Overload Recovery Time | ORT | $V_{IN} \times G > V_S$ | +25°C | | 0.1 | | μs |
| Total Harmonic Distortion + Noise | THD+N | $V_S = 15V$, $V_{OUT} = 10V_{P-P}$, $G = -1$, $f = 10kHz$, $R_L = 100\Omega$ | +25°C | | 100 | | dB |
| Channel Separation | | $f = 10kHz$ | +25°C | | 110 | | dB |
| Noise | | | | | | | |
| Input Voltage Noise | | $f = 0.1Hz$ to $10Hz$ | +25°C | | 5 | | μV_{RMS} |
| Input Voltage Noise Density | e_n | $f = 1kHz$ | +25°C | | 60 | | nV/\sqrt{Hz} |
| | | $f = 100kHz$ | +25°C | | 20 | | |
| Input Current Noise Density | i_n | $f = 1kHz$ | +25°C | | 4 | | fA/\sqrt{Hz} |
| Enable | | | | | | | |
| Enable High Input Voltage | V_{IH_OTF} | | +25°C | 1.2 | | | V |
| Enable Low Input Voltage | V_{IL_OTF} | | +25°C | | | 0.5 | V |
| Enable Hysteresis | | $V_S = 4.5V$ | +25°C | | 120 | | mV |
| | | $V_S = 24V$ | +25°C | | 180 | | |
| Enable Start-Up Time | $t_{OTF/SHDN}$ | | +25°C | | 3 | | μs |
| Shutdown Current | I_{SD} | $V_{OTF/SHDN} = 0V$ | +25°C | | 50 | 80 | μA |
| Thermal Protection | | | | | | | |
| Thermal Shutdown | | | | | 170 | | °C |
| Thermal Shutdown Recovery | | | | | 150 | | °C |

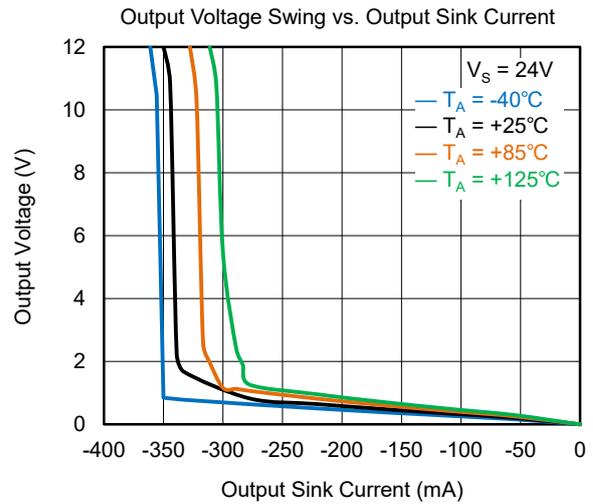
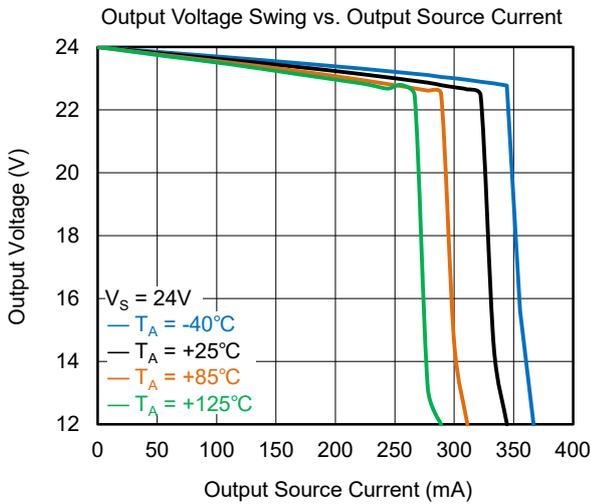
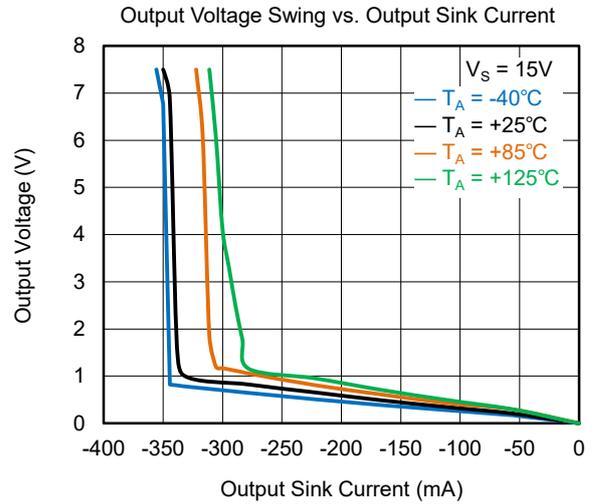
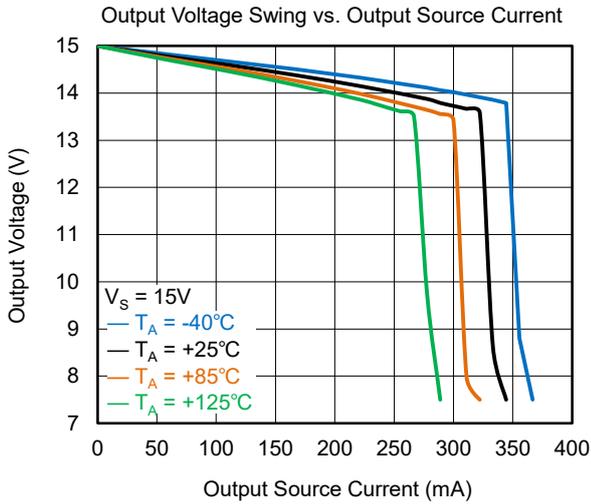
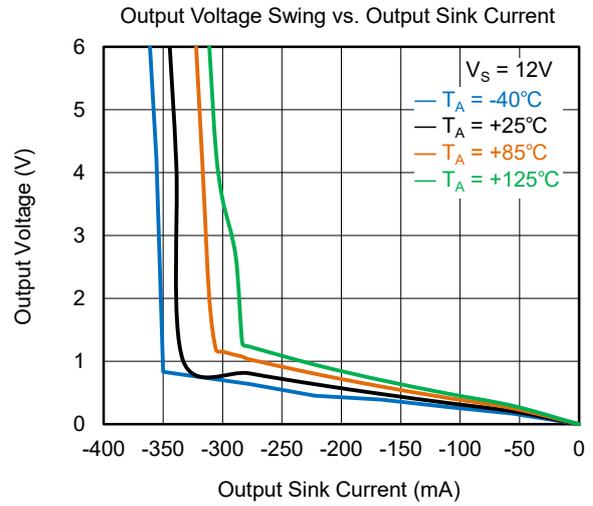
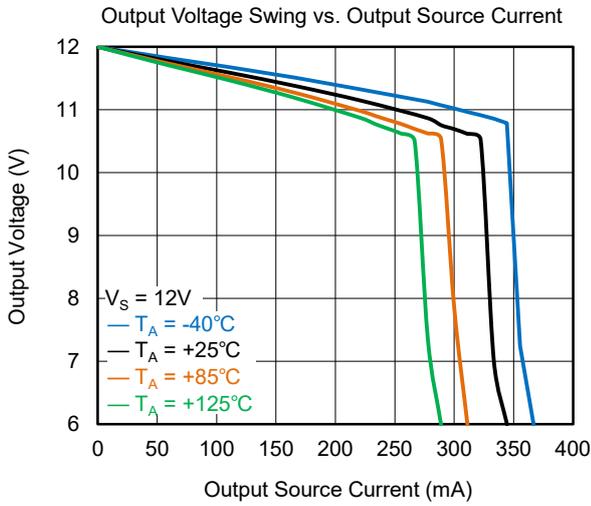
TYPICAL PERFORMANCE CHARACTERISTICS

At $T_A = +25^\circ\text{C}$, $V_S = 24\text{V}$, $V_{CM} = V_S/2$ and $R_L = 10\text{k}\Omega$, unless otherwise noted.



TYPICAL PERFORMANCE CHARACTERISTICS (continued)

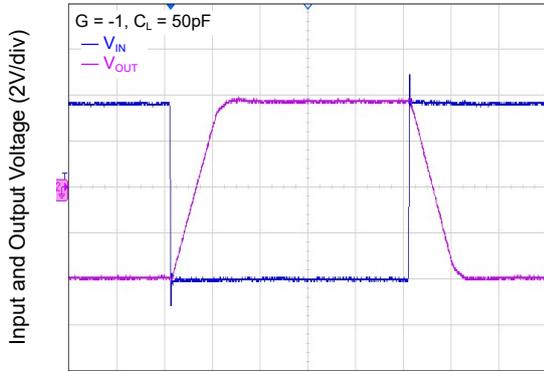
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TYPICAL PERFORMANCE CHARACTERISTICS (continued)

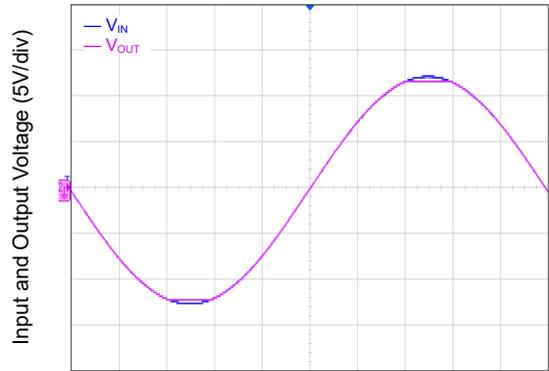
At $T_A = +25^\circ\text{C}$, $V_S = 24\text{V}$, $V_{CM} = V_S/2$ and $R_L = 10\text{k}\Omega$, unless otherwise noted.

Large-Signal Step Response



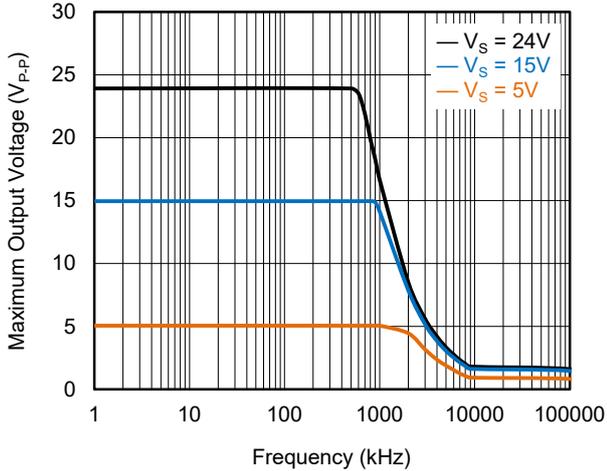
Time (200ns/div)

No Phase Reversal

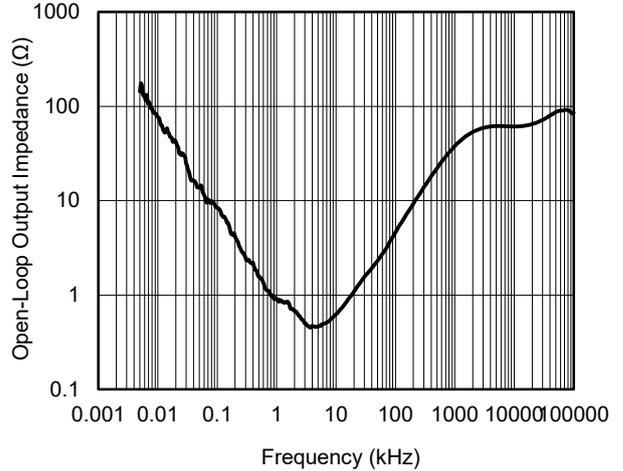


Time (100µs/div)

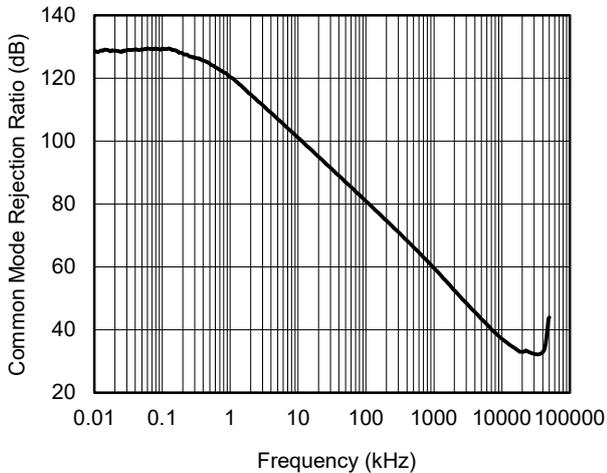
Maximum Output Voltage vs. Frequency



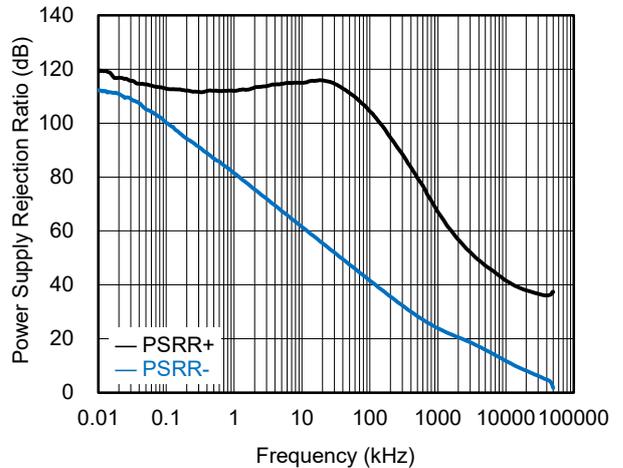
Open-Loop Output Impedance vs. Frequency



CMRR vs. Frequency



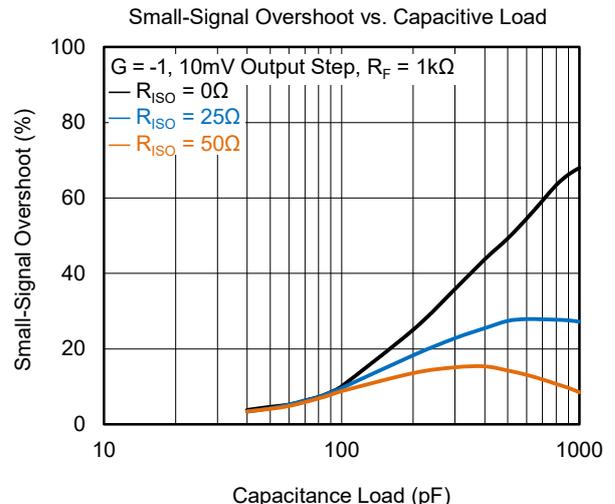
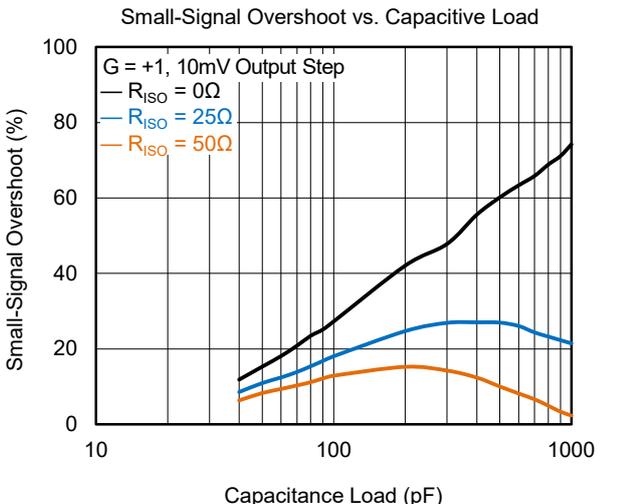
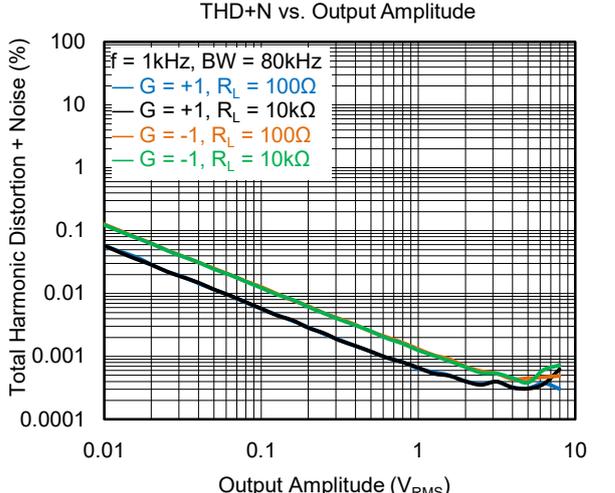
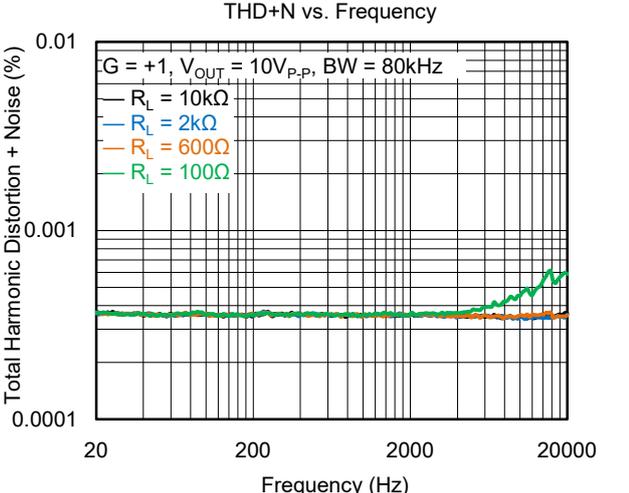
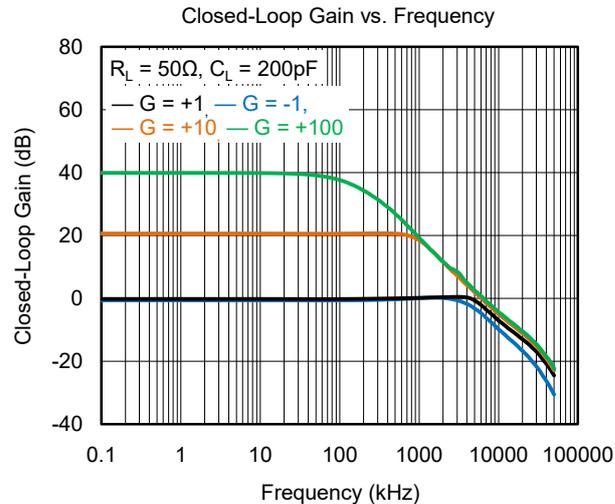
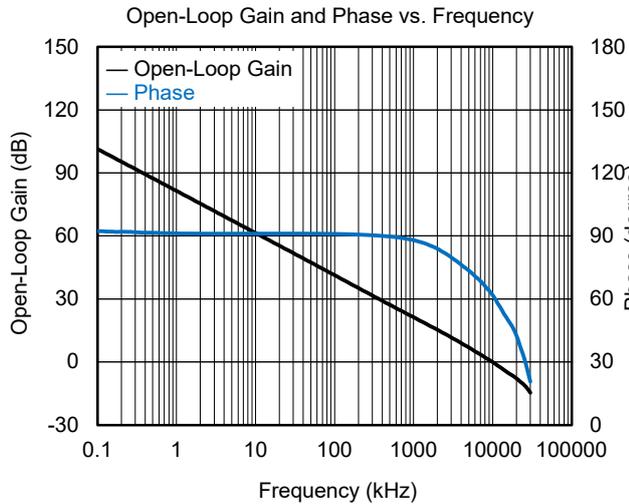
PSRR vs. Frequency



SGM8433-2 Low-Distortion, Dual-Power Amplifier with Integrated Protection for Resolver Drive

TYPICAL PERFORMANCE CHARACTERISTICS (continued)

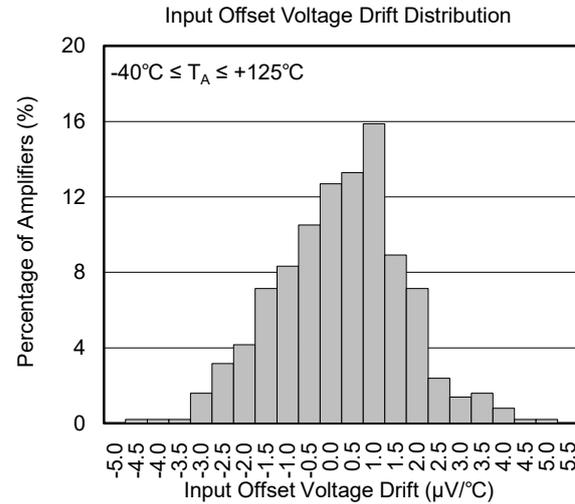
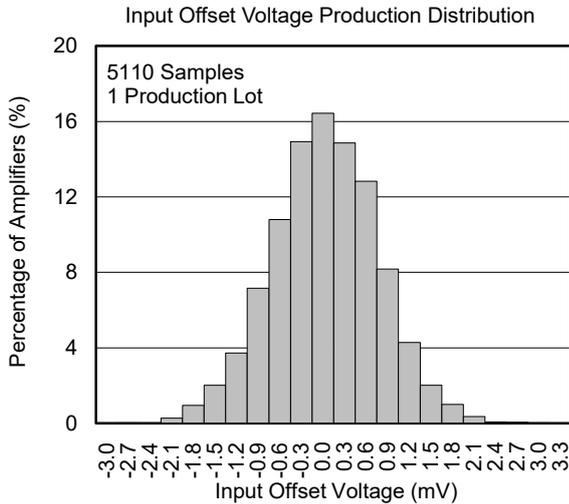
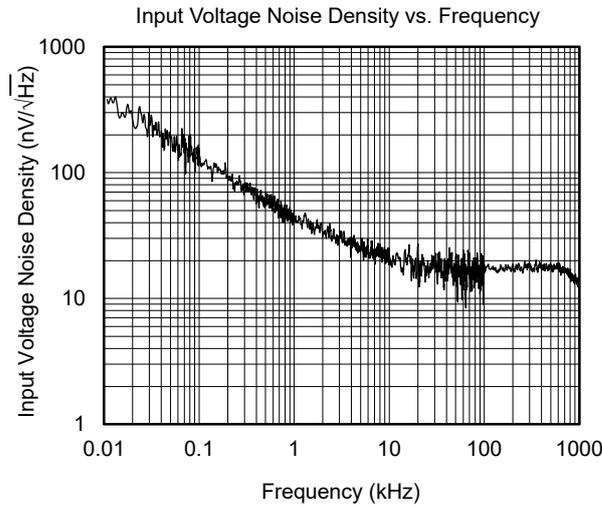
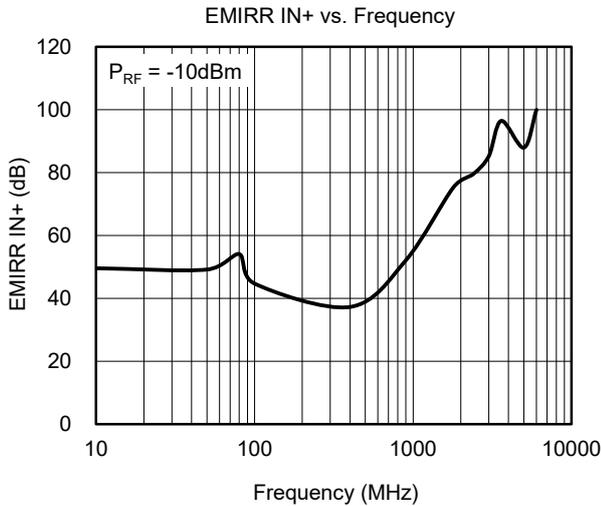
At $T_A = +25^\circ\text{C}$, $V_S = 24\text{V}$, $V_{CM} = V_S/2$ and $R_L = 10\text{k}\Omega$, unless otherwise noted.



SGM8433-2 Low-Distortion, Dual-Power Amplifier with Integrated Protection for Resolver Drive

TYPICAL PERFORMANCE CHARACTERISTICS (continued)

At $T_A = +25^\circ\text{C}$, $V_S = 24\text{V}$, $V_{CM} = V_S/2$ and $R_L = 10\text{k}\Omega$, unless otherwise noted.



DETAILED DESCRIPTION

The SGM8433-2 is a high performance operational amplifier that supports dual-power supply, rail-to-rail input and output, and has high output current drive capability. The device also comes with shutdown control, over-temperature and current-limit protection functions, which is specifically designed for applications involving resolvers.

Input and Output Range

The SGM8433-2 supports rail-to-rail input and output. The input common mode range is from $(-V_S) - 0.2V$ to $(+V_S) + 0.2V$. To achieve normal output performance in application, it is necessary to ensure that the input signal does not exceed this specification. If the input signal exceeds the limit, it can cause distortion and nonlinearities; in severe cases, it can lead to the device damage.

The SGM8433-2 has high current output capability and low output voltage swing from rail. The typical output voltage swing from rail is 20mV under the condition of $\pm 5mA$ output current. This makes the SGM8433-2 suitable for applications that require low output voltage swing from rail.

Over-Temperature and Shutdown Function

The SGM8433-2 is designed with over-temperature protection and a shutdown control ($\overline{OTF}/\overline{SHDN}$) pin. This pin is a dual function pin. When the $\overline{OTF}/\overline{SHDN}$ pin is pulled low, the SGM8433-2 enters shutdown mode, and the device's quiescent current is as low as 50 μA (typical value at +25°C). In shutdown mode, all output pins of the operational amplifier maintain a high-impedance state. When the $\overline{OTF}/\overline{SHDN}$ pin is pulled high, the SGM8433-2 is enabled, and the operational amplifier can operate normally.

The SGM8433-2 defaults to shutdown mode when the $\overline{OTF}/\overline{SHDN}$ pin is floating, if users want to enable the device, the $\overline{OTF}/\overline{SHDN}$ pin must be pulled high through an external pull-up resistor. Table 1 summarizes the control logic of the $\overline{OTF}/\overline{SHDN}$ pin. In addition, it should be noted that the absolute maximum rating for the $\overline{OTF}/\overline{SHDN}$ pin is 5.5V relative to $-V_S$ pin, so users should exercise caution when operating it.

Table 1. $\overline{OTF}/\overline{SHDN}$ Shutdown Control

| $\overline{OTF}/\overline{SHDN}$ Pin | SGM8433-2 State |
|--------------------------------------|-----------------------|
| High ($> V_{IH_OTF}$) | Enabled and Operating |
| Low ($< V_{IL_OTF}$) | Shutdown Mode |

The $\overline{OTF}/\overline{SHDN}$ pin's another function is used to indicate over-temperature protection events. This pin defaults to being pulled high. When the over-temperature event occurs and the junction temperature of SGM8433-2 exceeds the limit value, the $\overline{OTF}/\overline{SHDN}$ pin will actively become low and all outputs of the operational amplifier will enter a high-impedance state.

Thermal Shutdown

The SGM8433-2 design has a thermal shutdown (TSD) function. The device enters a shutdown state when the internal junction temperature exceeds the shutdown threshold of +170°C. In thermal shutdown mode, the output current is cut off, and the output pin remains in a high-impedance state. The SGM8433-2 has a thermal shutdown hysteresis temperature of 20°C. The device will automatically recover from TSD mode once the junction temperature drops to +150°C. In application, the SGM8433-2 should be operated at a junction temperature below +150°C, and the exposed pad should be connected to a larger ground plane to maximize thermal performance.

Current-Limit

The SGM8433-2 design has an output current-limit function that activates when overload events happen. The output source and sink current limits are 360mA (TYP) and 400mA (TYP), respectively. In application, the die temperature rises rapidly if the SGM8433-2 remains in current limitation for an extended period. This situation may cause the chip to enter thermal shutdown. Therefore, it is necessary for users to evaluate whether the SGM8433-2's output current can meet the normal operating requirements when designing circuits. It should be noted not to operate the equipment continuously under thermal hysteresis for a long time, as this behavior may cause irreversible damage to the device.

DETAILED DESCRIPTION (continued)

Input and Output Protection

The SGM8433-2 incorporates internal ESD protection circuits on both input and output pins, and equivalent input and output circuit is illustrated in the following figure.

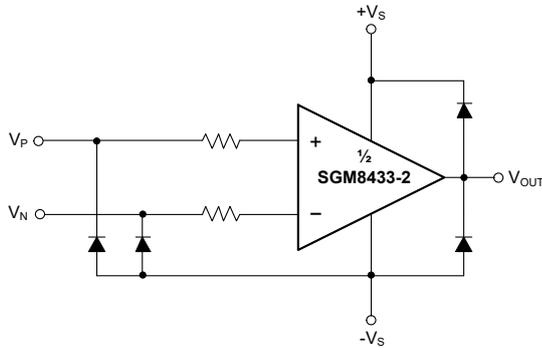


Figure 3. Equivalent Input and Output Circuit

For input and output pins, this protection primarily consists of current-steering diodes connected between the input and power supply pins. Therefore, it is crucial to keep the input voltage below the maximum rating and limit the input current to less than 10mA.

In addition, the SGM8433-2 supports large differential voltage inputs within the power supply range, making it suitable for use as a comparator in some applications.

Capacitive Load and Stability

The SGM8433-2 is designed for driving the 100pF capacitive load with unity-gain stable. If greater capacitive load must be driven in application, the circuit in Figure 4 can be used. In this circuit, the IR drop voltage generated by R_{ISO} is compensated by feedback loop.

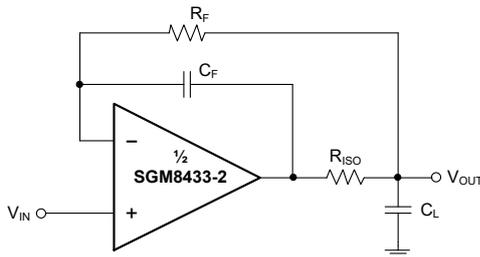


Figure 4. Circuit to Drive Heavy Capacitive Load

For the buffer circuit, another simpler compensation is shown in Figure 5. This method, called out-of-the-loop compensation, primarily uses a resistor to isolate the output pin and feedback network from the capacitive load. Functionally, it introduces a zero in the transfer function of the feedback network, which reduces the loop phase shift at higher frequencies. This method is effective, but the R_{ISO} will bring an IR drop voltage, so choosing an appropriate resistance value is crucial in actual applications. The selection of R_{ISO} can refer to the Small-Signal Overshoot vs. Capacitive Load.

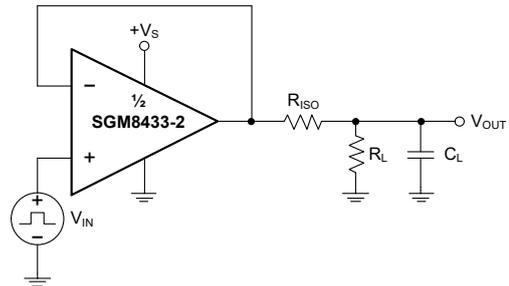


Figure 5. Circuit to Drive Capacitive Load

Power Supply Bypassing and Layout

Power supply pins are actually inputs to the amplifiers. Care must be taken to provide the amplifiers with a clean, low noise DC voltage source. Power supply bypassing is employed to provide a low-impedance path to ground for noise and undesired signals at all frequencies. This cannot be achieved with a single capacitor type; however, with a variety of capacitors in parallel, the bandwidth of power supply bypassing can be greatly extended. The bypass capacitors have two functions:

- ◆ Provide a low-impedance path for noise and undesired signals from the supply pins to ground.
- ◆ Provide local stored charge for fast switching conditions and minimize the voltage drop at the supply pins during transients. This is typically achieved with large electrolytic capacitors.

DETAILED DESCRIPTION (continued)

Good quality ceramic chip capacitors should be used and always kept as close as possible to the amplifier package. A parallel combination of a 0.1µF ceramic and a 10µF electrolytic capacitor covers a wide range of rejection for unwanted noise. The 10µF capacitor is less critical for high-frequency bypassing, and in most cases, one per supply line is sufficient. The values of capacitors are circuit-dependent and should be determined by the system's requirements.

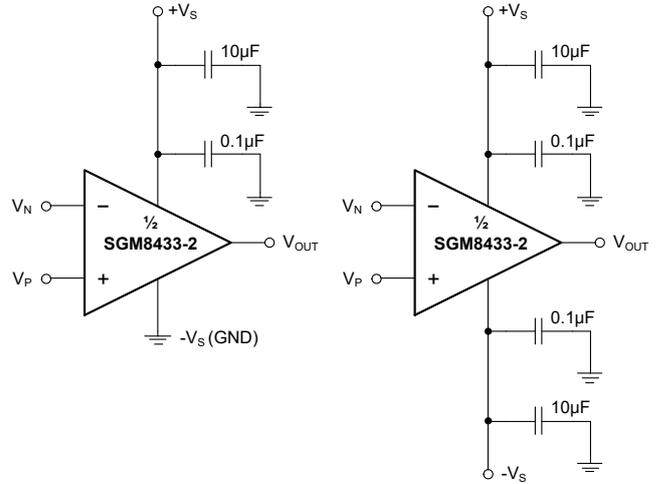


Figure 6. Amplifier with Bypass Capacitors

APPLICATION INFORMATION

The SGM8433-2 is a dual CMOS operational amplifier featuring rail-to-rail output, high voltage and high output drive. It operates within a wide voltage range of 4.5V to 24V, offers a high continuous output current of 230mA (MIN), and is available in a TSSOP-14B (Exposed Pad) package that provides efficient heat dissipation. These characteristics make the SGM8433-2 highly suitable for applications requiring both high operating voltage and high output current.

The SGM8433-2 has output current limit and thermal shutdown (TSD) functions. It can be flexibly applied to a resolver excitation circuit. The following chapter provides more detailed descriptions.

Resolver Excitation Circuit

The SGM8433-2's high continuous output current function makes it very suitable for resolver excitation circuit. Figure 7 shows the typical resolver excitation circuit using the SGM8433-2 and the SGM8212-1. This circuit includes two SGM8212-1s: one is used to provide a bias voltage buffer and the other is used as an inverting amplifier to obtain a signal with phase reversal.

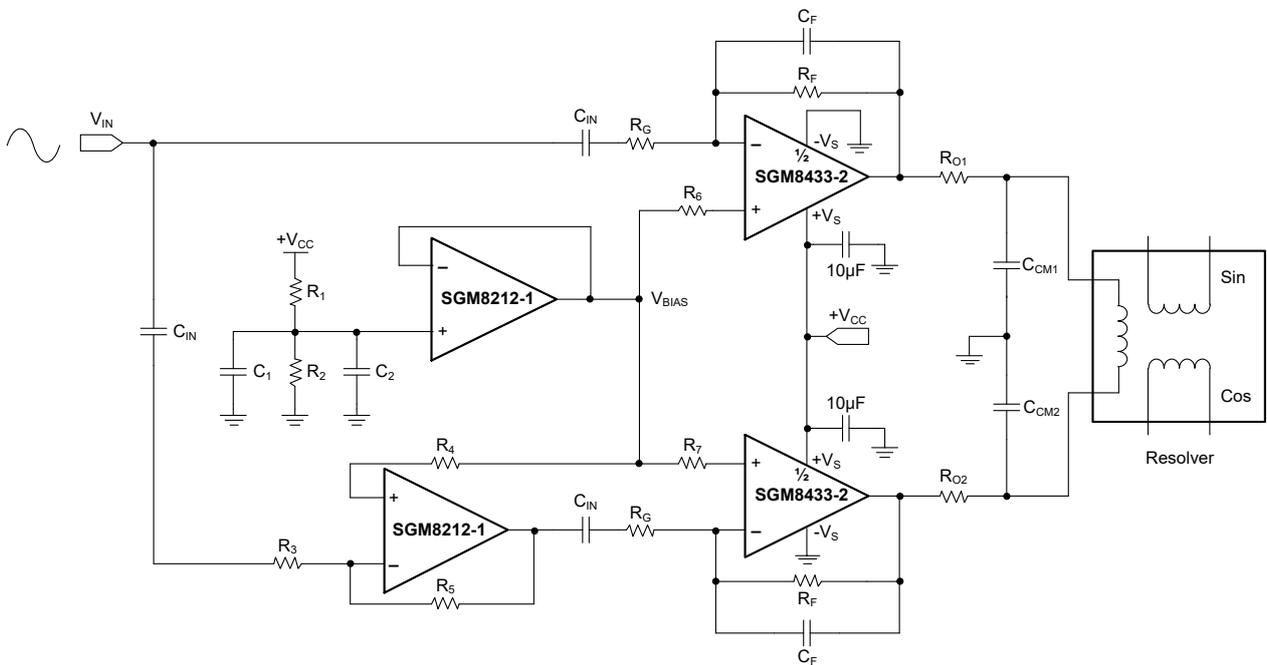


Figure 7. Resolver Excitation Circuit with SGM8212-1

SGM8433-2 Low-Distortion, Dual-Power Amplifier with Integrated Protection for Resolver Drive

APPLICATION INFORMATION (continued)

Figure 8 shows a simplified resolver excitation circuit without SGM8212-1. Its bias voltage is provided by a resistance voltage divider, and the input signal is a differential signal with a phase difference of 180 degrees.

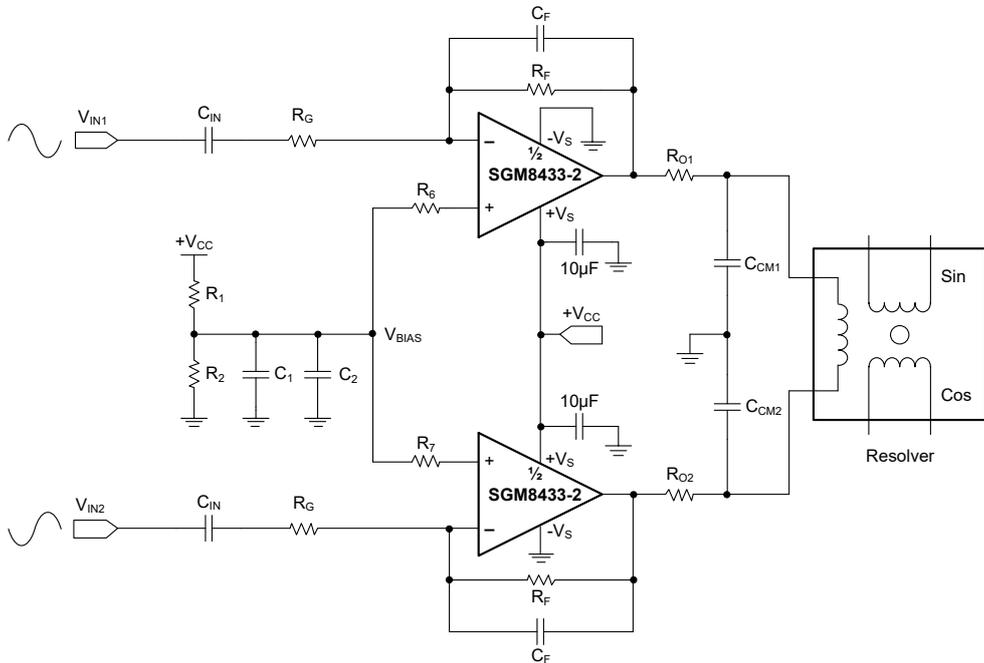


Figure 8. Simplified Resolver Excitation Circuit without SGM8212-1

Figure 9 shows a resolver excitation circuit with a pulse-width modulation (PWM) signal as the input. In this circuit, the SGM8212-1 is used as a buffer and provides the bias voltage. Two input PWM signals from the I/O pins of the microcontroller are filtered by a two-stage RC filter circuit and converted to a sine wave signal for use as an excitation input.

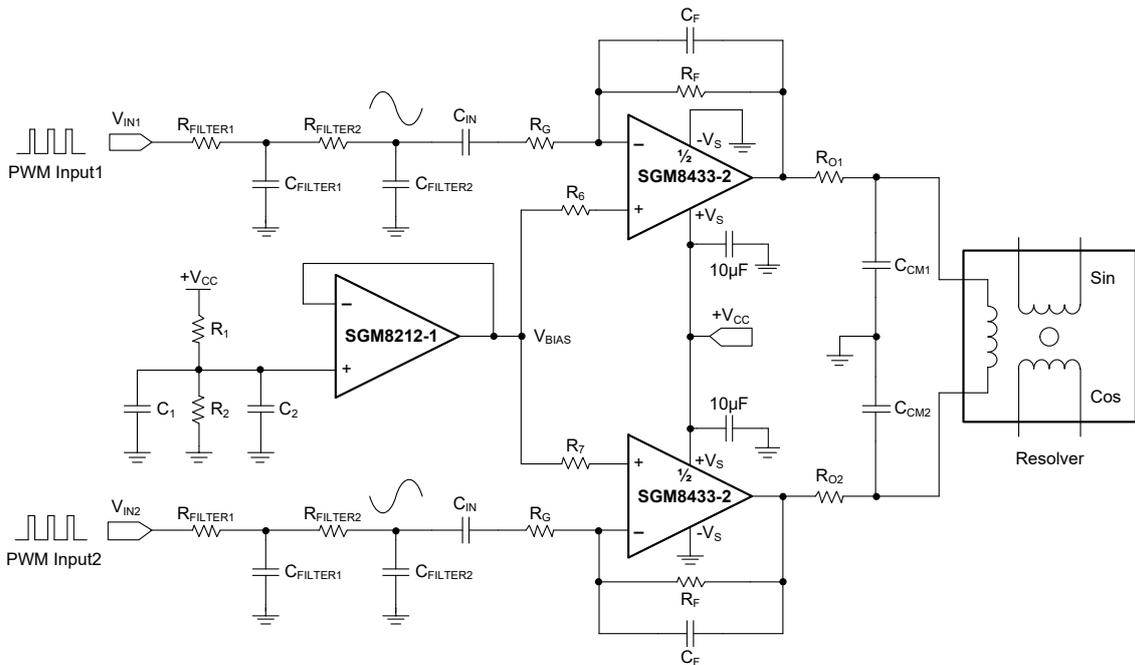


Figure 9. Resolver Excitation Circuit from PWM Input Signal

APPLICATION INFORMATION (continued)

Figure 10 shows the actual output waveform from a resolver excitation circuit, and the key circuit parameter design is shown in Table 2.

Figure 11 and Figure 12 respectively show the output voltage and the output current of the resolver excitation circuit.

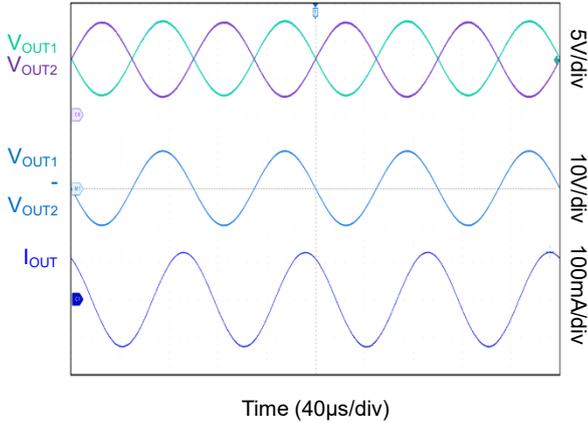


Figure 10. Actual Output Waveform from Resolver Excitation Circuit (+V_S = 15V, -V_S = 0V, f = 10kHz)

Table 2. Design Parameters

| Design Parameter | Example Value |
|---|-----------------------|
| Ambient Temperature Range | -40°C to +125°C |
| Supply Voltage | +15V |
| V _{BIAS} | +7.5V from SGM8212-1 |
| R _O | 0Ω |
| C _{CM} | No Connect |
| Gain | 2.5V/V |
| Input Signal Frequency | 10kHz |
| Resolver Excitation Input Voltage | 8V _{P-P} |
| Resolver Excitation Output Voltage | 20V _{P-P} |
| Output Current with Resolver Equivalent Circuit | ±130mA _{P-P} |

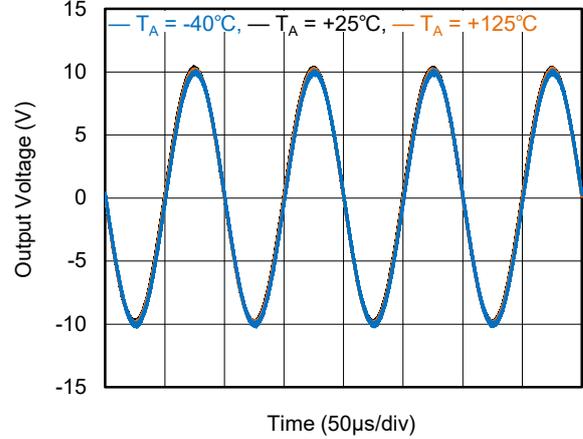


Figure 11. Output Voltage of Resolver Excitation Circuit

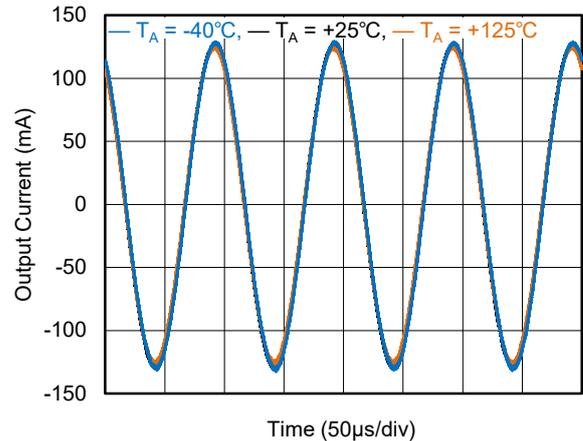


Figure 12. Output Current of Resolver Excitation Circuit

REVISION HISTORY

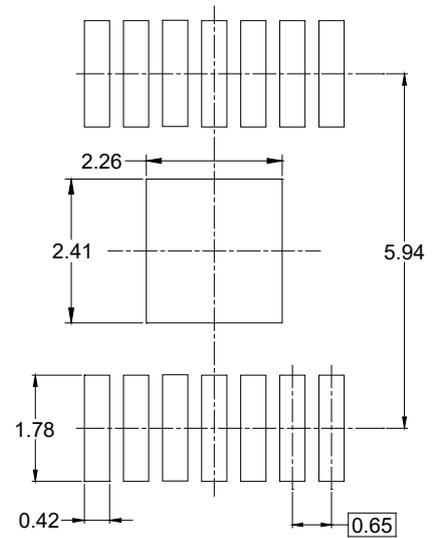
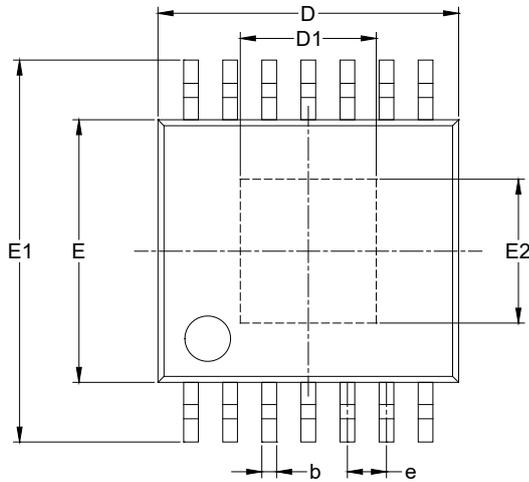
NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

| APRIL 2025 – REV.A to REV.A.1 | Page |
|--|-------------|
| Updated Electrical Characteristics section | 4 |

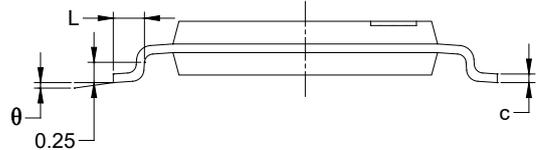
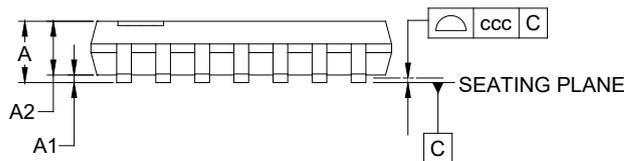
| Changes from Original (DECEMBER 2024) to REV.A | Page |
|---|-------------|
| Changed from product preview to production data | All |

PACKAGE OUTLINE DIMENSIONS

TSSOP-14B (Exposed Pad)



RECOMMENDED LAND PATTERN (Unit: mm)



| Symbol | Dimensions In Millimeters | | |
|----------|---------------------------|-----|-------|
| | MIN | NOM | MAX |
| A | - | - | 1.200 |
| A1 | 0.000 | - | 0.150 |
| A2 | 0.800 | - | 1.150 |
| b | 0.190 | - | 0.300 |
| c | 0.090 | - | 0.200 |
| D | 4.860 | - | 5.100 |
| D1 | 2.060 | - | 2.460 |
| E | 4.300 | - | 4.500 |
| E1 | 6.200 | - | 6.600 |
| E2 | 2.210 | - | 2.610 |
| e | 0.650 BSC | | |
| L | 0.450 | - | 0.750 |
| θ | 0° | - | 8° |
| ccc | 0.100 | | |

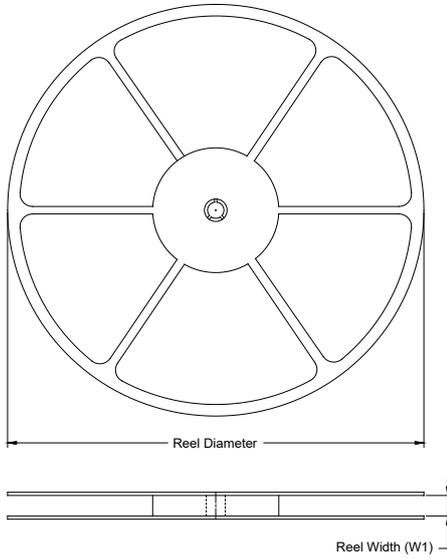
NOTES:

1. This drawing is subject to change without notice.
2. The dimensions do not include mold flashes, protrusions or gate burrs.
3. Reference JEDEC MO-153.

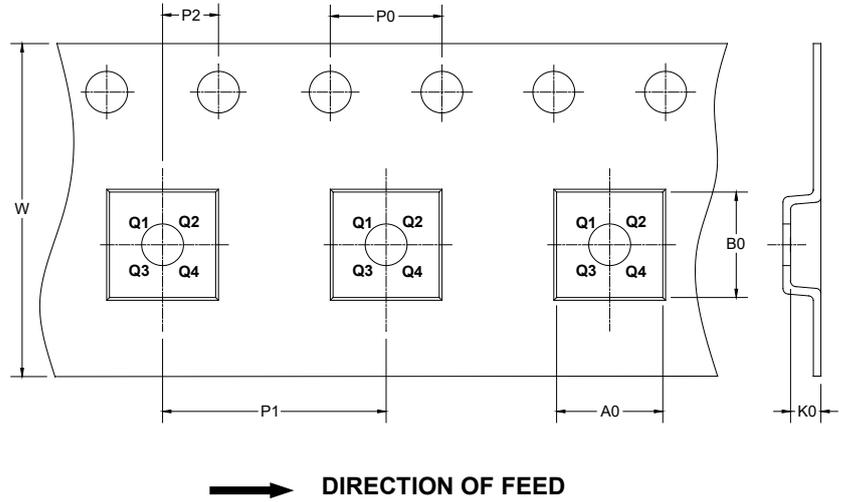
PACKAGE INFORMATION

TAPE AND REEL INFORMATION

REEL DIMENSIONS



TAPE DIMENSIONS



NOTE: The picture is only for reference. Please make the object as the standard.

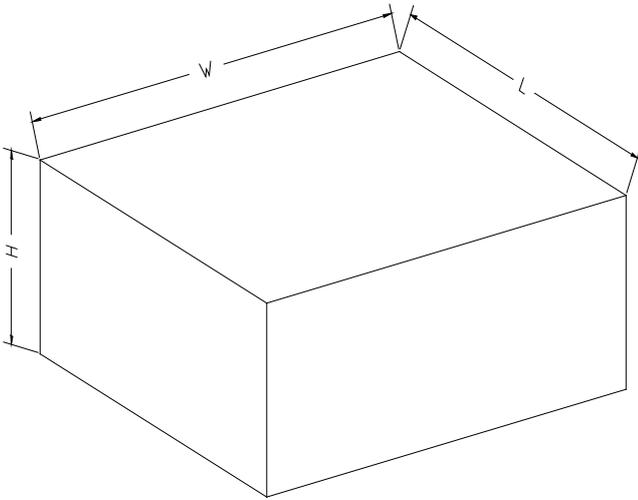
KEY PARAMETER LIST OF TAPE AND REEL

| Package Type | Reel Diameter | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P0 (mm) | P1 (mm) | P2 (mm) | W (mm) | Pin1 Quadrant |
|-------------------------|---------------|--------------------|---------|---------|---------|---------|---------|---------|--------|---------------|
| TSSOP-14B (Exposed Pad) | 13" | 12.4 | 6.80 | 5.40 | 1.50 | 4.0 | 8.0 | 2.0 | 12.0 | Q1 |

DD0001

PACKAGE INFORMATION

CARTON BOX DIMENSIONS



NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF CARTON BOX

| Reel Type | Length (mm) | Width (mm) | Height (mm) | Pizza/Carton |
|-----------|-------------|------------|-------------|--------------|
| 13" | 386 | 280 | 370 | 5 |

DD0002